At ST, we are creators and makers of semiconductor technologies. We work with our customers and partners to design and build products, solutions, and ecosystems that address their challenges and opportunities, and the need to support a more sustainable world.

WHAT WE DO
We create semiconductor solutions which are integrated into each of the billions of electronic devices people across the globe interact with every day. By getting more from technology to get more from life, ST stands for life.augmented.

WE ARE DRIVERS OF YOUR INNOVATION
We build products, solutions, and ecosystems that enable smarter mobility, more efficient power and energy management, and the wide-scale deployment of the internet of things and connectivity technologies.

At ST, we are creators of technology. Our technology starts with You.

KEY FACTS
• Integrated device manufacturer with 14 main manufacturing sites
• President and CEO: Jean-Marc Chery
• Public since 1994: traded in New York, Paris, and Milan
• Corporate headquarters: Geneva (CH)
• Committed to sustainability: Signatory of the United Nations global compact (UNGC), member of the responsible business alliance (RBA)
• Committed to be carbon neutral on scope 1 & 2 and partially scope 3 by 2027

SALES & MARKETING
• $17.3 billion revenue in 2023
• Offices in 40 countries
• Over 200,000 customers worldwide

PEOPLE & INNOVATION
• More than 50,000 employees worldwide
• ~120 nationalities
• ~9,500 people working in R&D and product design
• 20,000 active and pending patents
Semiconductor solutions: one of the industry’s broadest product portfolios

We create innovative semiconductor solutions based on:

- Dedicated Automotive ICs
- Analog, industrial and Power conversion ICs
- Discrete and power transistors
- MEMS and optical sensing solutions
- General purpose MCUs and MPUs, Secure solutions
- ASICs based on ST proprietary technologies

Trends that drive our innovation

**Smart Mobility**

Thinking differently about how we move around, reducing pollution and congestion through car electrification and digitalization

**Power & Energy**

More efficient power and energy management to address increasing global energy demand while reducing the environmental impact

**Cloud-connected Autonomous Things**

Supporting the proliferation of secure, connected, autonomous devices enabled by edge AI

Technology

We have a unique set of chip-manufacturing and packaging technologies enabling solutions for the markets we serve.

- MEMS for sensors & Micro-actuators
- FD-SOI CMOS FinFET through foundry
- Analog & RF CMOS
- eNVM CMOS
- Smart power: BCD (bipolar - CMOS - power DMOS)
- Discrete, power MOSFET, IGBT silicon carbide, gallium nitride
- Vertical intelligent power
- Optical sensing solutions

Manufacturing facilities

We believe in the benefits of owning manufacturing facilities and operating them in close proximity and coordination with its R&D operations.

Manufacturing locations:

- **France** (Crolles, Rousset, Tours)
- **Italy** (Agrate, Catania)
- **Italy** (Marcianise)
- **Sweden** (Norrköping)
- **Malta** (Kirkop)
- **Morocco** (Bouskoura)
- **Singapore**
- **Malaysia** (Muar)
- **China** (Shenzhen)
- **Philippines** (Calamba)

Packaging technologies:

- Leadframe
- Laminate
- Sensor module
- Wafer level